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FGH20N60SFD 600 V, 20 A Field Stop IGBT

Features

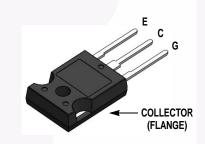
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 2.2 V @ I_C = 20A
- High Input Impedance
- Fast Switching
- RoHS Compliant

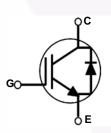
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description	Ratings	Unit	
V _{CES}	Collector to Emitter Voltage	600	V	
V _{GES}	Gate to Emitter Voltage	±20	V	
	Transient Gate-to-Emitter Voltage	±30	v	
I _C	Collector Current	@ T _C = 25°C	40	A
	Collector Current	@ T _C = 100 ^o C	20	A
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	60	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	165	W
	Maximum Power Dissipation	@ T _C = 100 ^o C	66	W
Т _Ј	Operating Junction Temperature	-55 to +150	°C	
T _{stg}	Storage Temperature Range	-55 to +150	°C	
Τ _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT) Thermal Resistance, Junction to Case		-	0.76	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	2.51	°C/W
R _{0JA} Thermal Resistance, Junction to Ambient		-	40	°C/W

March 2015

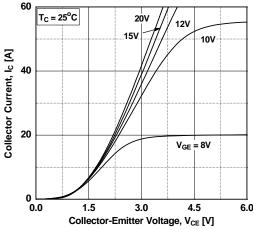
Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH20N60SFDTU	FGH20N60SFD	TO-247	Tube	N/A	N/A	30

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 V, I_{C} = 250 \mu A$	600	-	-	V
ΔBV_{CES} ΔT_J	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 250 μA, V _{CE} = V _{GE}	4.0	5.0	6.5	V
		I _C = 20 A, V _{GE} = 15 V		2.2	2.8	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 20 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$	-	2.4	-	V
Dynamic C	Characteristics		I			
C _{ies}	Input Capacitance		-	940	-	pF
C _{oes}	Output Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	110	-	pF
C _{res}	Reverse Transfer Capacitance		-	40	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	13	-	ns
t _r	Rise Time		-	16	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 20 A,	-	90	-	ns
t _f	Fall Time	$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,	-	24	48	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	0.37	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.16	-	mJ
E _{ts}	Total Switching Loss		-	0.53	-	mJ
t _{d(on)}	Turn-On Delay Time		-	12	-	ns
t _r	Rise Time		-	16	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{\rm CC} = 400 \text{ V}, I_{\rm C} = 20 \text{ A},$	-	95	-	ns
t _f	Fall Time	$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,	-	28	-	ns
		Inductive Load, $T_C = 125^{\circ}C$	-	0.4	-	mJ
	Turn-On Switching Loss					mJ
E _{on}	Turn-On Switching Loss Turn-Off Switching Loss		-	0.28	-	IIIJ
E _{on}		-	-	0.28	-	mJ
E _{on} E _{off} E _{ts}	Turn-Off Switching Loss					
E _{on} E _{off}	Turn-Off Switching Loss Total Switching Loss	V _{CE} = 400 V, I _C = 20 A, V _{GE} = 15 V		0.69		mJ

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V_{FM}	Diode Forward Voltage	$I_F = IUA$	$T_C = 25^{\circ}C$	-	1.9	2.5	V
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.7	-	
t	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	34	-	ns
۲r		I _F =10 A, di _F /dt = 200 A/μs	$T_{C} = 125^{\circ}C$	-	57	-	
Q _{rr}	Diode Reverse Recovery Charge	$r_{\rm F} = 10.73, {\rm dip/dt} = 200.74 {\rm m}^3$	$T_C = 25^{\circ}C$	-	41	-	nC
			$T_{C} = 125^{\circ}C$	-	96	-	







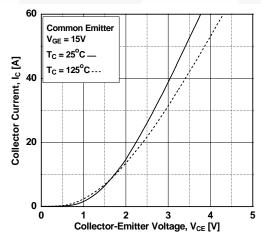


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

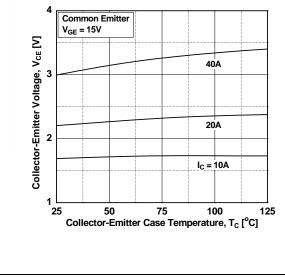


Figure 2. Typical Output Characteristics

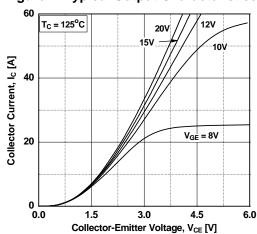


Figure 4. Transfer Characteristics

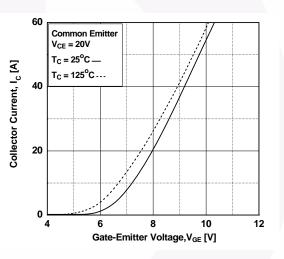
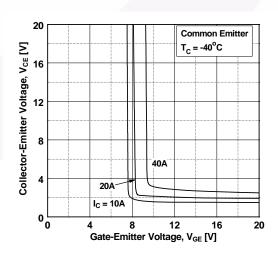
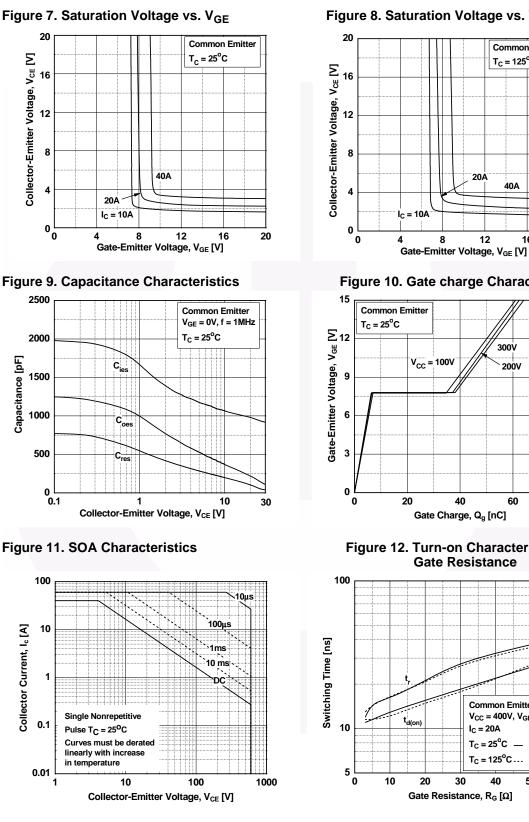


Figure 6. Saturation Voltage vs. V_{GE}





Typical Performance Characteristics

Figure 8. Saturation Voltage vs. V_{GE}

Common Emitter

T_C = 125°C

40A

16

20

Figure 10. Gate charge Characteristics

8

20A

12

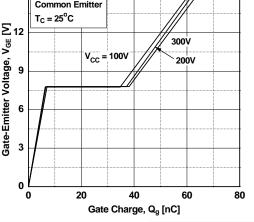
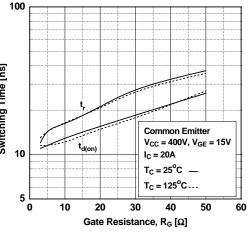
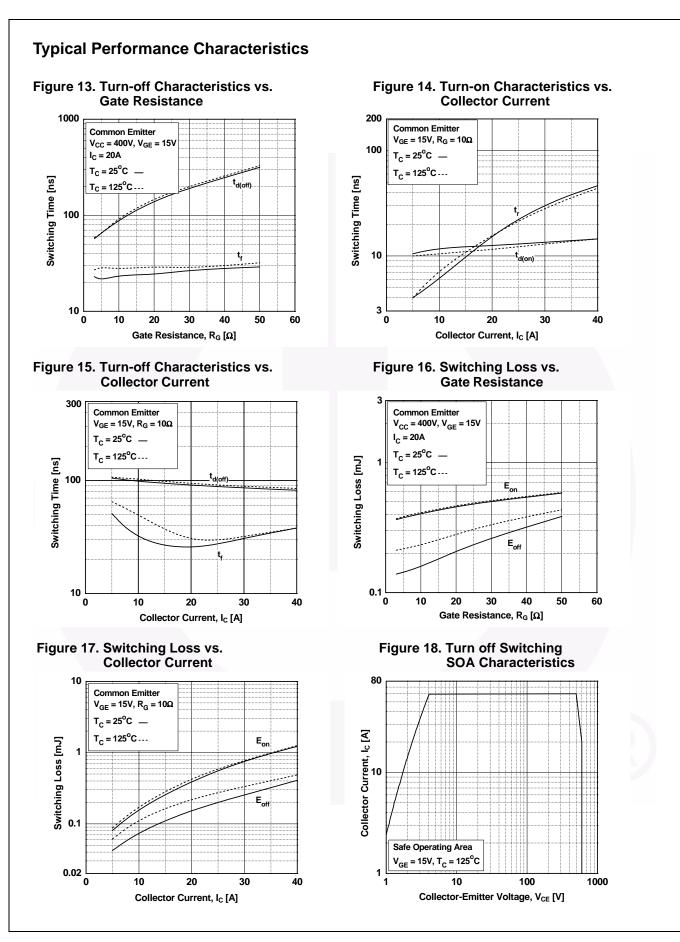


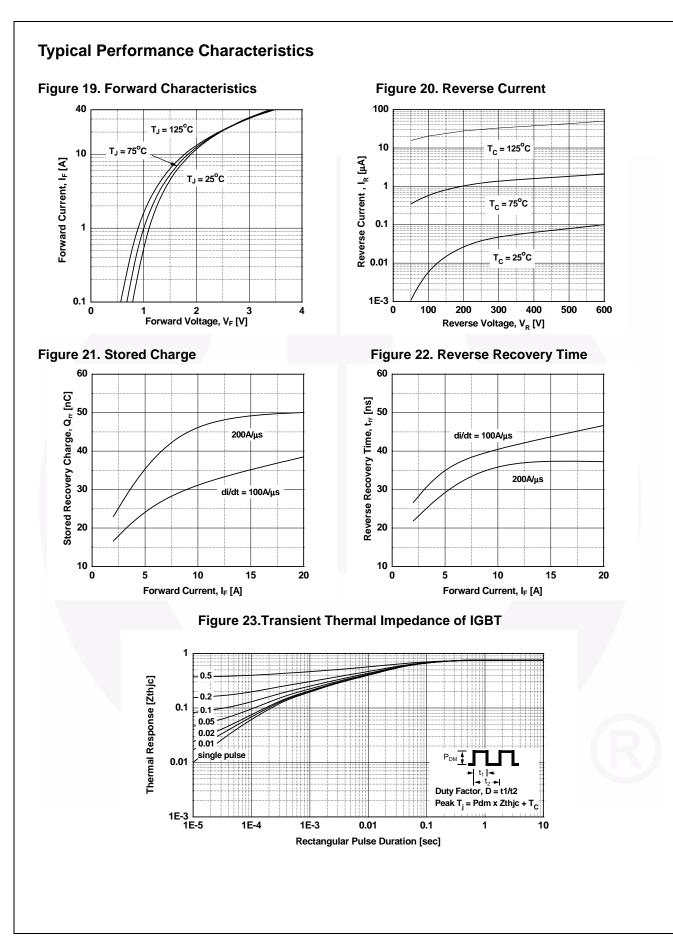
Figure 12. Turn-on Characteristics vs. **Gate Resistance**

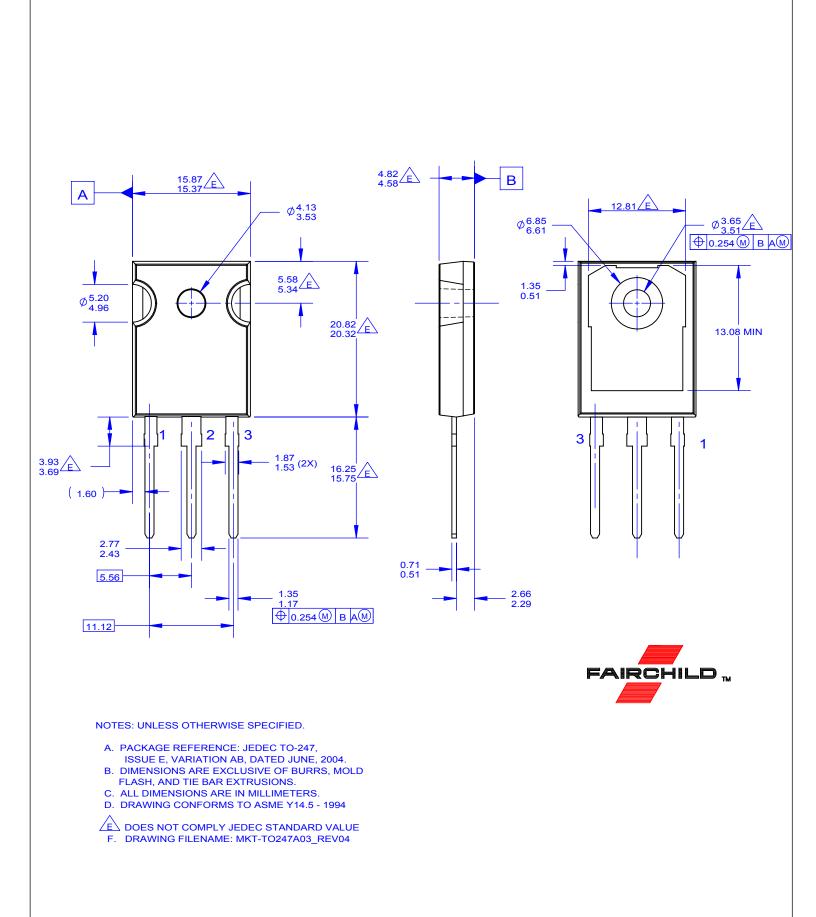


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